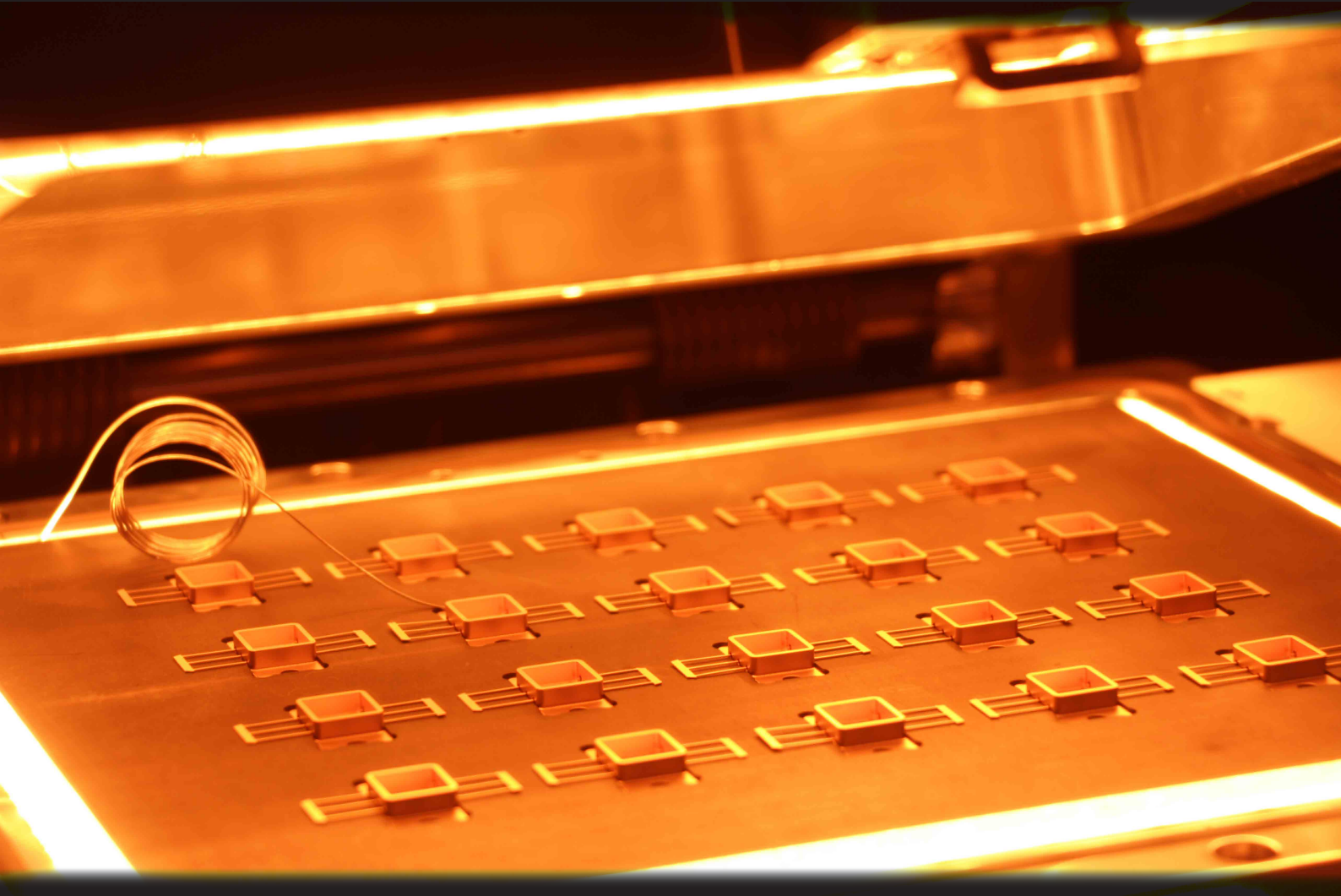


invacu
.com



Vacuum

Reflow

Soldering

Systems

VSU 12 / 28 / 45

Programmable vacuum ovens



XS
100 mm
100 mm



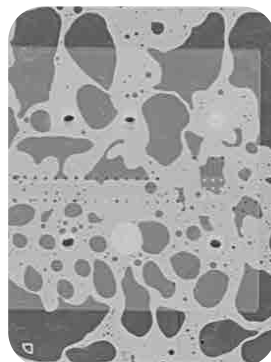
M
210 mm
260 mm

variety
of options

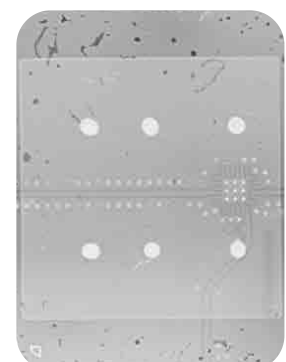
void-free attach

vacuum assisted
bonding process

xray comparison



no vacuum



with vacuum



Wide product range:

single sample R&D
to multi-batch
production
solutions

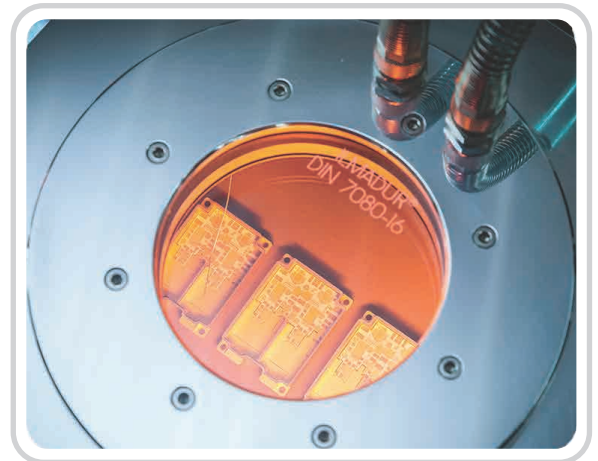
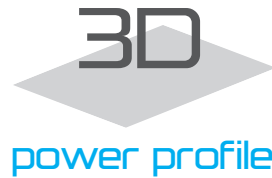
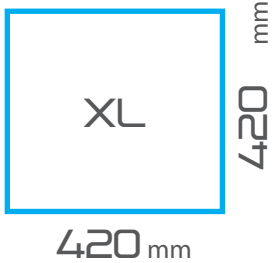


650 °C
max.



4.5 bar
max.

heating area



bottom & top
heating

low nitrogen
consumption

individual heater
control

high temperature
accuracy

formic acid bubbler
with
automatic refill

independent
overheat protection

*pick available options
and
get quote in website*



